

# Intel Data Center GPU Flex Series 170 16GB

Xe HPG PCIe 2022

## OVERVIEW

**16.0**  
FP32 TFLOPS**16 GB**  
VRAM—  
Memory Bandwidth**150 W**  
TDP

## PERFORMANCE METRICS

Precision	Peak TFLOPS	Bits	Type
INT8	250.0	8	Standard
FP32	16.0	32	Standard

## MEMORY SPECIFICATIONS

## POWER & EFFICIENCY

Capacity	16 GB	TDP	150 W
Type	—	Est. Max Power	173 W
Bandwidth	—	FP32 Efficiency	0.11 TFLOPS/W
Interface Width	—	FP16 Efficiency	—

## HARDWARE DETAILS

Vendor: Intel	Architecture: Xe HPG	Process Node: —
Form Factor: PCIe	Launch Year: 2022	Variant: 170 16GB